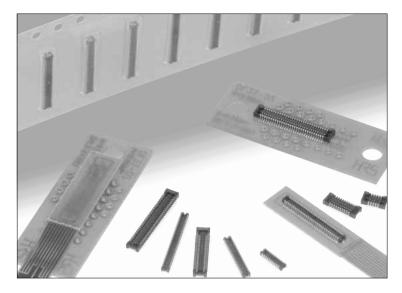
The product information in this catalog is for reference only. Please request the Engineering Drawing for the most current and accurate design information. All non-RoHS products have been discontinued, or will be discontinued soon. Please check the products status on the Hirose website RoHS search at www.hirose-connectors.com, or contact your Hirose sales representative.

0.4 mm Pitch, 0.98 mm Mated Height, Board-to-Board / Board-to-FPC Connectors

DF37 Series



Features

1. Reduced size and board-occupied area With the mated height of 0.98 mm, width of 2.98mm and length of 10.22 mm (40 positions) the connectors are one of the smallest in its class.

Sufficiently large flat areas allow pick-up with vacuum nozzles of automatic placement equipment.

- 2. Reliable electrical and mechanical connection Despite its small mated height, unique contact configuration, with a 2-point contacts and effective mating length of 0.25mm, assures highly reliable connection while confirming a complete mating with a definite tactile feel.
- 3. Self alignment

Recognizing the difficulties of mating extremely small connectors in limited spaces, the connectors will self-align within 0.3mm.

4. Physical shock and vibration protection

2-point contact assures electrical connection in a shock or vibration applications.

5. Solder wicking prevention

Nickel barriers (receptacles) and unique forming of the contacts (receptacles) prevent un-intentional solder wicking.

6. Contamination protection

Insulator walls protect the contact areas against flux splatter or other physical particles contamination.

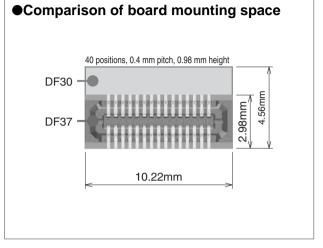
7. RoHS compliant

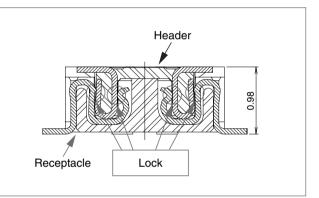
All components and materials comply with the requirements of EU Directive 2002/95/EC.

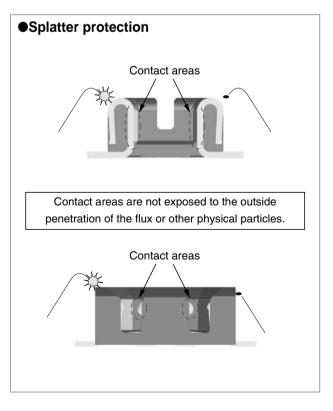
Applications

Mobile phones, digital cameras, digital camcorders and other thin portable devices requiring high reliability board-toboard/ board-to-FPC connections.

Further reduction of the board space.







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■Specifications

-						
Ratings	Current rating	0.3 A	Operating temperature range	-35°C to +85°C (Note 1)	Storage temperature range	-10°C to +60°C (Note 2)
5	Voltage rating	30 V AC, DC	Operating humidity range	RH 20% to 80%	Storage humidity range	RH 40% to 70% (Note 2)

Item	Specification	Conditions		
1.Insulation resistance	500 MΩ min	100 V DC		
2.Withstanding voltage	No flashover or insulation breakdown	100 V AC / 1minute		
3.Contact resistance	100 mΩ max.	20 mV AC, 1 kHz, 1 mA		
4.Vibration	No electrical discontinuity of 1 μ s or longer No damage or parts dislocation	Frequency: 10 to 55 Hz, single amplitude of 0.75 mm, 2 hours, 3 axis		
5.Humidity	Contact resistance: 100 m Ω max., Insulation resistance: 25 M Ω min.	96 hours at 40 $\pm 2^\circ C$ and humidity of 90 to 95% No damage or parts dislocation		
6.Temperature cycle	Contact resistance: $100 \text{ m}\Omega \text{ max.}$, Insulation resistance: $50 \text{ M}\Omega \text{ min.}$ No damage or parts dislocation	-55° C → 5 to 35° C → 85° C → 5 to 35° C Time: 30 min. → 10 min. → 30 min. → 10 min. 5 cycles		
7.Durability	Contact resistance: 100 mΩ max.	10 cycles		
8.Resistance to soldering heat	No deformation of components affecting performance	Reflow: At the recommended temperature profile Manual soldering: 350°C for 3 seconds		

Note 1: Includes temperature rise caused by current flow.

Note 2: The term "storage" here refers to products stored for a long period prior to board mounting and use.

The operating temperature and humidity range covers the non-conducting condition of connectors after board mounting and the temporary storage conditions of transportation, etc.

Note 3: Information contained in this catalog represents general requirements for this Series. Contact us for the drawings and specifications for a specific part number shown.

Materials

Receptacle

Part	Material	Finish	Remarks
Insulator	LCP	Color: Black	UL94V-0

Header

Part	Material	Finish	Remarks
Contacts	Phosphor bronze	Gold plated	

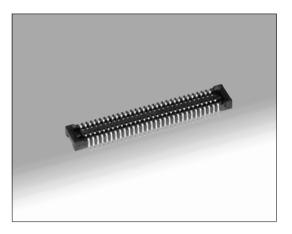
Ordering information

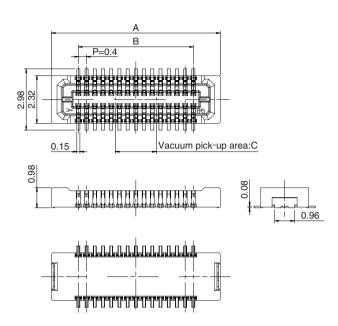
Receptacles / Headers

DF 37 C -	* DS - 0.4 V (51)			
0 2	Image: Object with the second secon			
Series name : DF37	Onnector style			
Onfiguration	DS: Receptacle			
B: with metal fittings, no bosses	DP: Header			
C: without metal fittings, no bosses	S Contact pitch : 0.4 mm			
Number of contacts	Terminal type V: SMT vertical mount			
10, 16, 20, 24, 30, 40, 50, 60	Packaging			
	(51): Embossed tape packaging (8,000 pieces per reel)			
	(53): Embossed tape packaging (1,000 pieces per reel)			

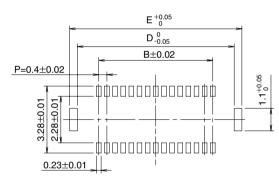
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Receptacles

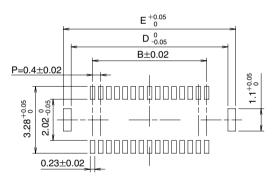




Recommended metal mask dimensions



Recommended PCB mounting pattern



All dimensions: mm

Part Number	CL No.	Number of Contacts	А	В	С	D	E	RoHS
DF37B-10DS-0.4V(51)	684-3036-7-51	10	4.22	1.6	0.8	3.7	4.46	
DF37B-16DS-0.4V(51)	684-3055-1-51	16	5.42	2.8	1.2	4.9	5.66	
DF37B-20DS-0.4V(51)	684-3000-0-51	20	6.22	3.6	1.6	5.7	6.46	
DF37B-24DS-0.4V(51)	684-3001-2-51	24	7.02	4.4	2	6.5	7.26	YES
DF37B-30DS-0.4V(51)	684-3002-5-51	30	8.22	5.6	2	7.7	8.46	
DF37B-40DS-0.4V(51)	684-3003-8-51	40	10.22	7.6	2.4	9.7	10.46	
DF37B-50DS-0.4V(51)	684-3004-0-51	50	12.22	9.6	2.8	11.7	12.46	
DF37B-60DS-0.4V(51)	684-3005-3-51	60	14.22	11.6	3.2	13.7	14.46	

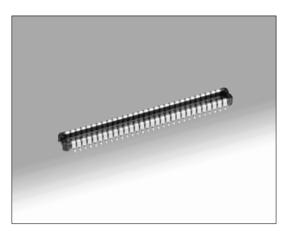
Note 1: Tape and reel packaging (8,000 pieces/reel).

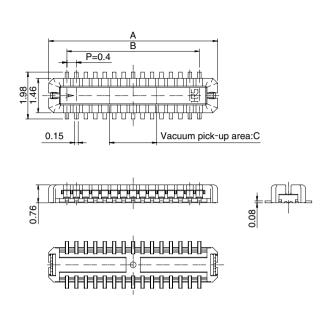
Order by number of reels.

Note 2: This connector is NOT polarized.

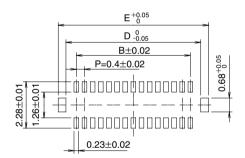
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Headers

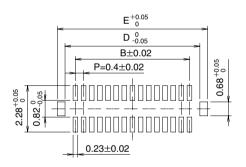




Recommended metal mask dimensions



Recommended PCB mounting pattern



All dimensions: mm

Part Number	CL No.	Number of Contacts	А	В	С	D	E	RoHS
DF37B-10DP-0.4V(51)	684-3037-0-51	10	3.14	1.6	0.8	2.62	3.38	
DF37B-16DP-0.4V(51)	684-3057-7-51	16	4.34	2.8	1.2	3.82	4.58	
DF37B-20DP-0.4V(51)	684-3008-1-51	20	5.14	3.6	1.6	4.62	5.38	
DF37B-24DP-0.4V(51)	684-3009-4-51	24	5.94	4.4	2	5.42	6.18	YES
DF37B-30DP-0.4V(51)	684-3010-3-51	30	7.14	5.6	2	6.62	7.38	TES
DF37B-40DP-0.4V(51)	684-3011-6-51	40	9.14	7.6	2.4	8.62	9.38	
DF37B-50DP-0.4V(51)	684-3012-9-51	50	11.14	9.6	2.8	10.62	11.38	
DF37B-60DP-0.4V(51)	684-3013-1-51	60	13.14	11.6	3.2	12.62	13.38	

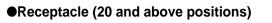
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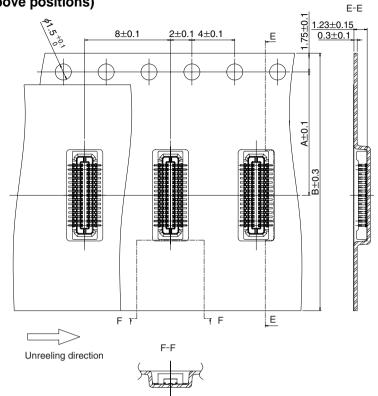
Order by number of reels.

Note 2: This connector is NOT polarized.

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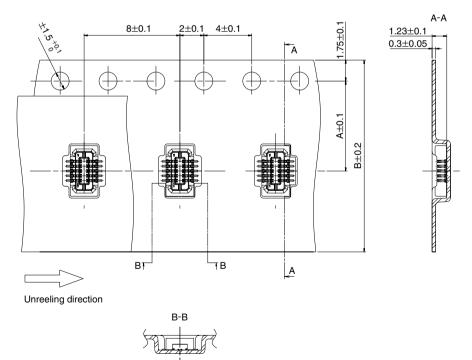
Packaging Specifications Embossed Carrier Tape Dimensions





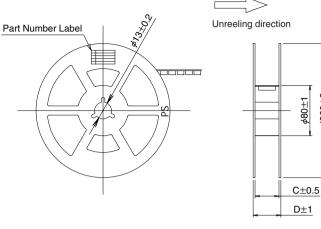
Embossed Carrier Tape Dimensions

•Receptacle (less than 20 positions)



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Reel Dimensions



All dimensions: mm

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Part Number	А	В	С	D
DF37B-10DS-0.4V(51)	7.5	16	17.5	21.5
DF37B-16DS-0.4V(51)	7.5	16	17.5	21.5
DF37B-20DS-0.4V(51)	7.5	16	17.5	21.5
DF37B-24DS-0.4V(51)	7.5	16	17.5	21.5
DF37B-30DS-0.4V(51)	11.5	24	25.5	29.5
DF37B-40DS-0.4V(51)	11.5	24	25.5	29.5
DF37B-50DS-0.4V(51)	11.5	24	25.5	29.5
DF37B-60DS-0.4V(51)	11.5	24	25.5	29.5
DF37B-60DS-0.4V(51)	-		25.5	29.5

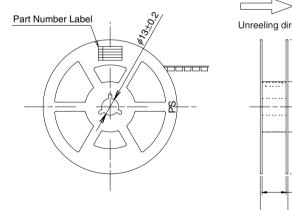
Tape and reel packaging (8,000 pieces/reel).

Embossed Carrier Tape Dimensions

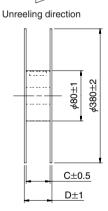
EFE

•Reel Dimensions

Header



سلا



All dimensions: mm

А	В	С	D
5.5	12	13.5	17.5
7.5	16	17.5	21.5
7.5	16	17.5	21.5
7.5	16	17.5	21.5
7.5	16	17.5	21.5
11.5	24	25.5	29.5
11.5	24	25.5	29.5
11.5	24	25.5	29.5
	5.5 7.5 7.5 7.5 7.5 7.5 11.5 11.5	5.5 12 7.5 16 7.5 16 7.5 16 7.5 16 7.5 16 11.5 24 11.5 24	5.5 12 13.5 7.5 16 17.5 7.5 16 17.5 7.5 16 17.5 7.5 16 17.5 7.5 16 17.5 7.5 16 17.5 7.5 16 17.5 11.5 24 25.5 11.5 24 25.5

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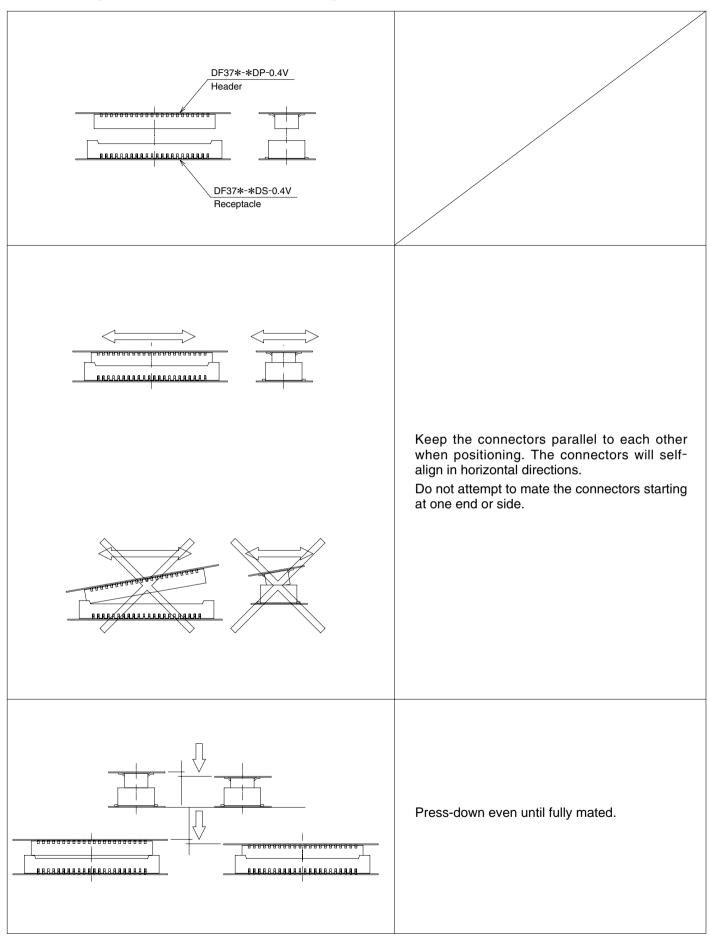
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● Usage Recommendations

1.Recommended temperature profile					
	Temperature (??)				
	Temperature (°C) 250 r 250 °C				
	220°C				
	$\frac{60 \sec \max}{180^{\circ}C} = \frac{1}{100^{\circ}C}$				
	150 - 150°C -				
	90~120sec				
	50 -				
	Room temperature /				
	0 50 100 150 200 250 300				
	Time (sec.)				
	same conditions, provided that there is a return to normal temperature between the first and second cycle. Note 2: The temperature profile indicates the board surface temperature at the point of contacts with the connector terminals.				
2.Recommended manual soldering	Manual soldering: 340±10°C for 3 seconds				
3.Recommended screen thickness and open	Thickness: 0.12 mm				
area ratio (Pattern area ratio)					
1 Board warpage	Open area ratio: Receptacle:80%, Plug: 70%				
4.Board warpage	Open area ratio: Receptacle:80%, Plug: 70% Maximum of 0.02 mm at the connector center, with both ends of the				
4. Doard warpage					
5.Cleaning conditions	Maximum of 0.02 mm at the connector center, with both ends of the				
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Handling Precautions when Mating Connectors



Handling Precautions When Un-mating Connectors

DF37*-*DP-0.4V Header BEBBBBBBBBBBBBBBBBBBBBBB BEBBBBBBBBBB	Fully mated
	Lift even, keeping both connectors parallel to each other
Pitch orientation	 When handling, circumstances may prevent the connectors from being kept parallel when un-mating. One end may be lifted as shown. However, to use this procedure the connector must be mounted on sufficiently rigid circuit board. Any deflection of the board during this opera- tion may result in damage to the connector or solder joints.
Corner orientation	Do not attempt to start the un-mating of the connectors from one side or corner. Failure to exercise caution when un-mating the connectors mounted on the non-rigid FPC may also result in connector breakage. It is the responsibility of the user to perform verification of the repeated mating / un-mating cycles with the connectors mounted on the applicable FPC.
REPORTED TO THE PART OF THE PA	When the rigidity of the FPC is low, there is a risk that the connector could break as illustrat- ed in the diagram at left. Please use the connectors after performing a check of repeated operation with the FPC that the customer will be using. Evaluative results of FPC rigidity and various items are available. Please inquire.

A282 **HS**